

中心剖面

NOTE:

1. Electrical

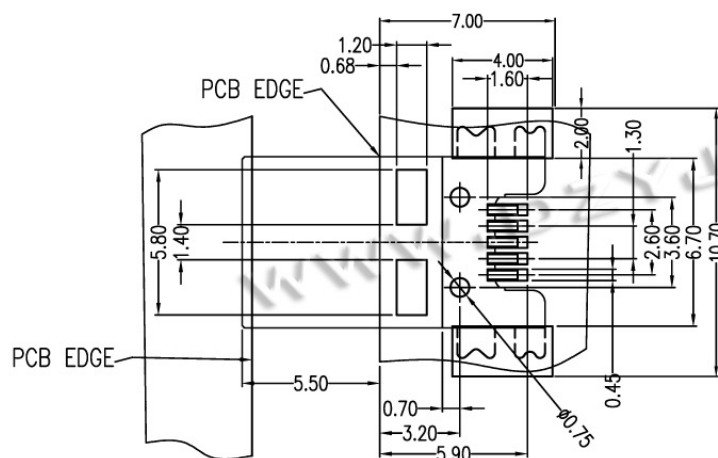
- 1.1. Rated Voltage: 30V AC maximum
- 1.2. Rated Current: 1A min.
- 1.3. DIELECTRIC WITHSTANDING VOLTAGE: 100VAC, 1MIN
- 1.4. INSULATION RESISTANCE:
 - a, UNMATED: 100M OHMS MIN AT 500 VDC
 - b, MATED: 10M OHMS MIN AT 150 VDC
- 1.5. Contact Resistance: 30mΩ Max.

2. Mechanical

- 2.1. Mating Force Max: 3.70kgf max.
- 2.2. Removal Force Min: 1.0kgf min.
- 2.3. Durability: 0.81~2.05Kgf after 10,000 cycles at 100±50 cycles per hour.
3. Ambient Temperature: -30° C To +80° C

BOM:

5	卡勾	SUS301, T=0.40±0.02mm	镀亮镍	2
4	外壳	SUS304, T=0.20mm	镀可焊镍	1
3	前盖	LCP UL 94V-0	黑色	1
2	胶心	LCP UL 94V-0	黑色	1
1	PIN	C5191, T=0.20mm	镀前金后锡	5
项次	名称	材质	表面	数量

RECOMMENDED PCB Layout
TOL: ±0.05mm

深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X' ±2" X.X' ±0.5"	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: MICRO USB 5P公头 全贴片	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HXC65-USBD05-923	MOLD NO.
UNIT: mm [inch] SCALE: 1:1 SIZE: A4	APPROVED BY: 邱敏	DATE : 2014-02-23	DRAW NO: HYC-USB16011111	SHEET NO. 1 OF 1